mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Data sheet

BMA280 Digital, triaxial acceleration sensor

Bosch Sensortec





BMA280: Data sheet

Document revision	1.8
Document release date	01 August 2014
Document number	BST-BMA280-DS000-11
Technical reference code(s)	0 273 141 148
Notes	Data in this document are subject to change without notice. Product photos and pictures are for illustration purposes only and may differ from the real product's appearance. Not intended for publishing



BMA280

14 BIT, DIGITAL, TRIAXIAL ACCELERATION SENSOR WITH INTELLIGENT ON-CHIP MOTION-TRIGGERED INTERRUPT CONTROLLER

Key features

- Ultra-Small package
- Digital interface
- Programmable functionality
- On-chip FIFO
- On-chip interrupt controller

LGA package (12 pins), footprint 2mm x 2mm, height 0.95mm

SPI (4-wire, 3-wire), I²C, 2 interrupt pins V_{DDIO} voltage range: 1.2V to 3.6V Acceleration ranges $\pm 2g/\pm 4g/\pm 8g/\pm 16g$ Low-pass filter bandwidths 500Hz - <8Hz up to an max. output data read out of 2kHz (unfiltered) Integrated FIFO with a depth of 32 frames Mation triaggered interrupt signal generation for

Motion-triggered interrupt-signal generation for

- new data
- any-motion (slope) detection
- tap sensing (single tap / double tap)
- orientation recognition
- flat detection
- low-g/high-g detection
- no-motion / inactivity detection

• Ultra-low power

Low current consumption, short wake-up time, advanced features for system power management

- Temperature sensor
- RoHS compliant, halogen-free

Typical applications

- Display profile switching
- Menu scrolling, tap / double tap sensing
- Gaming
- Pedometer / step counting
- Free-fall detection
- E-compass tilt compensation
- Drop detection for warranty logging
- Advanced system power management for mobile applications

General description

The BMA280 is a triaxial, low-g acceleration sensor with digital output for consumer applications. It allows measurements of acceleration in three perpendicular axes. An evaluation circuitry (ASIC) converts the output of a micromechanical acceleration-sensing structure (MEMS) that works according to the differential capacitance principle.

Package and interfaces of the BMA280 have been defined to match a multitude of hardware requirements. Since the sensor features an ultra-small footprint and a flat package it is ingeniously suited for mobile applications.

BST-BMA280-DS000-11 | Revision 1.8 | August 2014

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



The BMA280 offers a variable V_{DDIO} voltage range from 1.2V to 3.6V and can be programmed to optimize functionality, performance and power consumption in customer specific applications. In addition it features an on-chip interrupt controller enabling motion-based applications without use of a microcontroller.

The BMA280 senses tilt, motion, inactivity and shock vibration in cell phones, handhelds, computer peripherals, man-machine interfaces, virtual reality features and game controllers.

© Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



Index of Contents

1. SPECIFICATION	8
2. ABSOLUTE MAXIMUM RATINGS	11
3. BLOCK DIAGRAM	12
4. FUNCTIONAL DESCRIPTION	13
4.1 SUPPLY VOLTAGE AND POWER MANAGEMENT	
4.2 Power modes	14
4.3 Sensor data	
4.3.1 ACCELERATION DATA	-
4.4 Self-test	20
4.5 OFFSET COMPENSATION	21
4.5.1 Slow compensation4.5.2 Fast compensation4.5.3 Manual compensation4.5.4 Inline calibration	23 24
4.6 NON-VOLATILE MEMORY	25
4.7 INTERRUPT CONTROLLER	26
 4.7.1 GENERAL FEATURES 4.7.2 MAPPING TO PHYSICAL INTERRUPT PINS (INTTYPE TO INT PIN#) 4.7.3 ELECTRICAL BEHAVIOUR (INT PIN# TO OPEN-DRIVE OR PUSH-PULL) 4.7.4 NEW DATA INTERRUPT 4.7.5 SLOPE / ANY-MOTION DETECTION 4.7.6 TAP SENSING 4.7.7 ORIENTATION RECOGNITION 4.7.8 FLAT DETECTION 4.7.9 LOW-G INTERRUPT 4.7.10 HIGH-G INTERRUPT 4.7.11 NO-MOTION / SLOW MOTION DETECTION 	27 28 28 29 31 34 39 40 40 41
4.8 Softreset	
5. FIFO OPERATION	45
5.1 FIFO OPERATING MODES	45
5.2 FIFO DATA READOUT	
5.3 FIFO FRAME COUNTER AND OVERRUN FLAG	
5.4 FIFO INTERRUPTS	



6.	REGISTER DESCRIPTION	48
	6.1 GENERAL REMARKS	48
	6.2 Register MAP	49
	REGISTER 0x00 (BGW_CHIPID)	50
	REGISTER 0x02 (ACCD_X_LSB)	50
	REGISTER 0x03 (ACCD_X_MSB)	51
	REGISTER 0x04 (ACCD_Y_LSB)	52
	REGISTER 0x05 (ACCD_Y_MSB)	53
	REGISTER 0x06 (ACCD_Z_LSB)	54
	REGISTER 0x07 (ACCD_Z_MSB)	55
	REGISTER 0x08 (ACCD_TEMP)	56
	REGISTER 0x09 (INT_STATUS_0)	57
	REGISTER 0x0A (INT_STATUS_1)	58
	REGISTER 0x0B (INT_STATUS_2)	59
	REGISTER 0x0C (INT_STATUS_3)	60
	REGISTER 0x0E (FIFO_STATUS)	61
	REGISTER 0x0F (PMU_RANGE)	62
	REGISTER 0x10 (PMU_BW)	62
	REGISTER 0x11 (PMU_LPW)	63
	REGISTER 0x12 (PMU_LOW_NOISE)	64
	REGISTER 0x13 (ACCD_HBW)	65
	REGISTER 0x14 (BGW_SOFTRESET)	66
	REGISTER 0x16 (INT_EN_0)	66
	REGISTER 0x17 (INT_EN_1)	67
	REGISTER 0x18 (INT_EN_2)	68
	REGISTER 0x19 (INT_MAP_0)	69
	REGISTER 0x1A (INT_MAP_1)	70
	REGISTER 0x1B (INT_MAP_2)	71
	REGISTER 0x1E (INT_SRC)	72
	REGISTER 0x20 (INT_OUT_CTRL)	73
	REGISTER 0x21 (INT_RST_LATCH)	74
	REGISTER 0x22 (INT_0)	74
	REGISTER 0x23 (INT_1)	75
	REGISTER 0x24 (INT_2)	75



BMA280 Data sheet

REGISTER 0x25 (INT_3)	
REGISTER 0x26 (INT_4)	76
REGISTER 0x27 (INT_5)	77
REGISTER 0x28 (INT_6)	
REGISTER 0x29 (INT_7)	
REGISTER 0x2A (INT_8)	79
REGISTER 0x2B (INT_9)	80
REGISTER 0x2C (INT_A)	
REGISTER 0x2D (INT_B)	
REGISTER 0x2E (INT_C)	
REGISTER 0x2F (INT_D)	
REGISTER 0x30 (FIFO_CONFIG_0)	
REGISTER 0x32 (PMU_SELF_TEST)	
REGISTER 0x33 (TRIM_NVM_CTRL)	
REGISTER 0x34 (BGW_SPI3_WDT)	
REGISTER 0x36 (OFC_CTRL)	
REGISTER 0x37 (OFC_SETTING)	
REGISTER 0x38 (OFC_OFFSET_X)	
REGISTER 0x39 (OFC_OFFSET_Y)	
REGISTER 0x3A (OFC_OFFSET_Z)	
REGISTER 0x3B (TRIM_GP0)	
REGISTER 0x3C (TRIM_GP1)	
REGISTER 0x3E (FIFO_CONFIG_1)	
REGISTER 0x3F (FIFO_DATA)	95
7. DIGITAL INTERFACES	
7.1 SERIAL PERIPHERAL INTERFACE (SPI)	
7.2 INTER-INTEGRATED CIRCUIT (I ² C) 7.2.1 SPI and I ² C Access Restrictions	
7.2.1 SPI AND PC ACCESS RESTRICTIONS	104
8. PIN-OUT AND CONNECTION DIAGRAM	105
8.1 PIN-OUT	
8.2 CONNECTION DIAGRAM 4-WIRE SPI	
8.3 CONNECTION DIAGRAM 3-WIRE SPI	
8.4 Connection diagram I ² C	





9. PACKAGE	109
9.1 OUTLINE DIMENSIONS	
9.2 SENSING AXES ORIENTATION	
9.3 LANDING PATTERN RECOMMENDATION	
9.4 Marking	
9.4.1 Mass production samples 9.4.2 Engineering samples	112 112
9.5 SOLDERING GUIDELINES	113
9.6 HANDLING INSTRUCTIONS	
9.7 TAPE AND REEL SPECIFICATION	115
9.7.1 ORIENTATION WITHIN THE REEL	116
9.8 ENVIRONMENTAL SAFETY	
9.8.1 HALOGEN CONTENT	117 117
10. LEGAL DISCLAIMER	118
10.1 ENGINEERING SAMPLES	
10.2 PRODUCT USE	
10.3 APPLICATION EXAMPLES AND HINTS	
11. DOCUMENT HISTORY AND MODIFICATION	119

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



1. Specification

Unless stated otherwise, the given values are over lifetime, operating temperature and voltage ranges. Minimum/maximum values are $\pm 3\sigma$.

OPERATING CONDITIONS							
Parameter	Symbol	Condition	Min	Тур	Max	Units	
Acceleration Range	GFS2g GFS4g GFS8g GFS16g	Selectable via serial digital interface		±2 ±4 ±8 ±16		g g g g	
Supply Voltage Internal Domains	V _{DD}		1.62	2.4	3.6	V	
Supply Voltage I/O Domain	V _{DDIO}		1.2	2.4	3.6	V	
Voltage Input Low Level	V _{IL}	SPI & I²C			$0.3V_{\text{DDIO}}$	-	
Voltage Input High Level	V _{IH}	SPI & I²C	$0.7V_{\text{DDIO}}$			-	
Voltage Output Low Level	V_{OL}	I _{OL} = 3mA, SPI & I ² C			$0.2V_{\text{DDIO}}$	-	
Voltage Output High Level	V _{OH}	I _{OH} = 3mA, SPI	$0.8V_{\text{DDIO}}$			-	
Total Supply Current in Normal Mode	I _{DD}	T_A =25°C, ODR _{max.} V_{DD} = V_{DDIO} = 2.4V		130		μA	
Total Supply Current in Suspend Mode	I _{DDsum}	$T_A=25^{\circ}C$ $V_{DD} = V_{DDIO} = 2.4V$		2.1		μA	
Total Supply Current in Deep Suspend Mode	I _{DDdsum}	$T_{A}=25^{\circ}C$ $V_{DD}=V_{DDIO}=2.4V$		1		μΑ	
Total Supply Current in Low-power Mode 1	I _{DDIp1}	T_A =25°C, unfiltered V _{DD} = V _{DDIO} = 2.4V sleep duration = 25ms		6.5		μA	

Table 1: Parameter specification

BST-BMA280-DS000-11 | Revision 1.8 | August 2014

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



Total Supply Current in Low-power Mode 2	I _{DDlp2}	T_A =25°C, unfiltered V_{DD} = V_{DDIO} = 2.4V sleep duration = 25ms		66		μΑ
Total Supply Current in Standby Mode	I _{DDsbm}	$T_A=25^{\circ}C$ $V_{DD} = V_{DDIO} = 2.4V$		62		μA
Wake-Up Time 1	t _{w,up1}	from Low-power Mode 1 or Suspend Mode or Deep Suspend Mode, ODR _{max.}		1.3	1.8	ms
Wake-Up Time 2	t _{w,up2}	from Low-power Mode 2 or Stand-by Mode, ODR _{max.}		1	1.2	ms
Start-Up Time	t _{s,up}	POR, ODR _{max.}			3	ms
Non-volatile memory (NVM) write-cycles	n _{NVM}				15	cycles
Operating Temperature	T _A		-40		+85	°C
		OUTPUT SIGNAL				
Parameter	Symbol	Condition	Min	Тур	Max	Units
	-			4096		
	S _{2g} S _{4g}	g _{FS2g} , T _A =25°C				LSB/g LSB/g
Sensitivity	S _{2g}	g _{FS2g} , T _A =25°C g _{FS4g} , T _A =25°C		4096		LSB/g
Sensitivity	S _{2g} S _{4g}	g _{FS2g} , T _A =25°C		4096 2048		LSB/g LSB/g
Sensitivity Sensitivity Temperature Drift	S _{2g} S _{4g} S _{8g}	$g_{FS2g}, T_A=25^{\circ}C$ $g_{FS4g}, T_A=25^{\circ}C$ $g_{FS8g}, T_A=25^{\circ}C$		4096 2048 1024		LSB/g LSB/g LSB/g
Sensitivity	S_{2g} S_{4g} S_{8g} S_{16g}	$g_{FS2g}, T_A=25^{\circ}C$ $g_{FS4g}, T_A=25^{\circ}C$ $g_{FS8g}, T_A=25^{\circ}C$ $g_{FS16g}, T_A=25^{\circ}C$ $g_{FS2g},$		4096 2048 1024 512		LSB/g LSB/g LSB/g LSB/g
Sensitivity Temperature Drift	S_{2g} S_{4g} S_{8g} S_{16g} TCS	$g_{FS2g}, T_A=25^{\circ}C$ $g_{FS4g}, T_A=25^{\circ}C$ $g_{FS8g}, T_A=25^{\circ}C$ $g_{FS16g}, T_A=25^{\circ}C$ $g_{FS2g},$ Nominal V _{DD} supplies $g_{FS2g}, T_A=25^{\circ}C,$ nominal V _{DD} supplies,		4096 2048 1024 512 0.015		LSB/g LSB/g LSB/g LSB/g %/K
Sensitivity Temperature Drift Zero-g Offset Zero-g Offset	S_{2g} S_{4g} S_{8g} S_{16g} TCS Off	$g_{FS2g}, T_A=25^{\circ}C$ $g_{FS4g}, T_A=25^{\circ}C$ $g_{FS8g}, T_A=25^{\circ}C$ $g_{FS16g}, T_A=25^{\circ}C$ $g_{FS2g},$ Nominal V _{DD} supplies $g_{FS2g}, T_A=25^{\circ}C,$ nominal V _{DD} supplies, over life-time $g_{FS2g},$		4096 2048 1024 512 0.015 ±50		LSB/g LSB/g LSB/g %/K mg
Sensitivity Temperature Drift Zero-g Offset Zero-g Offset	S_{2g} S_{4g} S_{8g} S_{16g} TCS Off TCO	$g_{FS2g}, T_A=25^{\circ}C$ $g_{FS4g}, T_A=25^{\circ}C$ $g_{FS8g}, T_A=25^{\circ}C$ $g_{FS16g}, T_A=25^{\circ}C$ $g_{FS2g},$ Nominal V _{DD} supplies $g_{FS2g}, T_A=25^{\circ}C,$ nominal V _{DD} supplies, over life-time $g_{FS2g},$		4096 2048 1024 512 0.015 ±50 ±1.0		LSB/g LSB/g LSB/g %/K mg mg/K
Sensitivity Temperature Drift Zero-g Offset Zero-g Offset Temperature Drift	S_{2g} S_{4g} S_{8g} S_{16g} TCS Off TCO bw_8	$g_{FS2g}, T_A=25^{\circ}C$ $g_{FS4g}, T_A=25^{\circ}C$ $g_{FS16g}, T_A=25^{\circ}C$ $g_{FS16g}, T_A=25^{\circ}C$ $g_{FS2g}, Nominal V_{DD} supplies$ $g_{FS2g}, T_A=25^{\circ}C, nominal V_{DD} supplies, over life-time$ $g_{FS2g}, Nominal V_{DD} supplies$ $2^{nd} order filter,$		$ \begin{array}{c} 4096\\ 2048\\ 1024\\ 512\\ 0.015\\ \pm 50\\ \pm 1.0\\ 8\\ 16\\ 31\\ \end{array} $		LSB/g LSB/g LSB/g %/K mg mg/K Hz
Sensitivity Temperature Drift Zero-g Offset Zero-g Offset	S_{2g} S_{4g} S_{8g} TCS Off TCO bw_8 bw_{16}	$g_{FS2g}, T_A=25^{\circ}C$ $g_{FS4g}, T_A=25^{\circ}C$ $g_{FS8g}, T_A=25^{\circ}C$ $g_{FS16g}, T_A=25^{\circ}C$ $g_{FS2g},$ Nominal V _{DD} supplies $g_{FS2g}, T_A=25^{\circ}C,$ nominal V _{DD} supplies, over life-time $g_{FS2g},$ Nominal V _{DD} supplies $g_{FS2g},$ Nominal V _{DD} supplies		4096 2048 1024 512 0.015 ±50 ±1.0 8 16 31 63		LSB/g LSB/g LSB/g %/K mg mg/K Hz Hz Hz Hz
Sensitivity Temperature Drift Zero-g Offset Zero-g Offset Temperature Drift	S_{2g} S_{4g} S_{8g} TCS Off TCO bw_8 bw_{16} bw_{31}	$g_{FS2g}, T_A=25^{\circ}C$ $g_{FS4g}, T_A=25^{\circ}C$ $g_{FS16g}, T_A=25^{\circ}C$ $g_{FS16g}, T_A=25^{\circ}C$ $g_{FS2g}, Nominal V_{DD} supplies$ $g_{FS2g}, T_A=25^{\circ}C, nominal V_{DD} supplies, over life-time$ $g_{FS2g}, Nominal V_{DD} supplies$ $2^{nd} order filter,$		4096 2048 1024 512 0.015 ±50 ±1.0 8 16 31 63 125		LSB/g LSB/g LSB/g %/K mg Mg/K Hz Hz Hz Hz Hz Hz
Sensitivity Temperature Drift Zero-g Offset Zero-g Offset Temperature Drift	S_{2g} S_{4g} S_{8g} S_{16g} TCS Off TCO bw_8 bw_{16} bw_{63}	$g_{FS2g}, T_A=25^{\circ}C$ $g_{FS4g}, T_A=25^{\circ}C$ $g_{FS8g}, T_A=25^{\circ}C$ $g_{FS16g}, T_A=25^{\circ}C$ $g_{FS2g},$ Nominal V _{DD} supplies $g_{FS2g}, T_A=25^{\circ}C,$ nominal V _{DD} supplies, over life-time $g_{FS2g},$ Nominal V _{DD} supplies $g_{FS2g},$ Nominal V _{DD} supplies		4096 2048 1024 512 0.015 ±50 ±1.0 8 16 31 63 125 250		LSB/g LSB/g LSB/g %/K mg Mg/K Hz Hz Hz Hz Hz Hz
Sensitivity Temperature Drift Zero-g Offset Zero-g Offset Temperature Drift	S_{2g} S_{4g} S_{8g} S_{16g} TCS Off TCO bw_8 bw_{16} bw_{63} bw_{125}	$g_{FS2g}, T_A=25^{\circ}C$ $g_{FS4g}, T_A=25^{\circ}C$ $g_{FS8g}, T_A=25^{\circ}C$ $g_{FS16g}, T_A=25^{\circ}C$ $g_{FS2g},$ Nominal V _{DD} supplies $g_{FS2g}, T_A=25^{\circ}C,$ nominal V _{DD} supplies, over life-time $g_{FS2g},$ Nominal V _{DD} supplies $g_{FS2g},$ Nominal V _{DD} supplies		4096 2048 1024 512 0.015 ±50 ±1.0 8 16 31 63 125		LSB/g LSB/g LSB/g %/K mg Mg/K Hz Hz Hz Hz Hz Hz

BST-BMA280-DS000-11 | Revision 1.8 | August 2014

NL

Nonlinearity

Bosch Sensortec

%FS

±0.5

best fit straight line,

gFS2g

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.

BOSCH	BMA280 Data sheet			Pag	ge 10	
Output Noise Density	n _{rms}	g _{FS2g} , T _A =25°C Nominal V _{DD} supplies Normal mode		120		µg/√Hz
Temperature Sensor Measurement Range	Ts		-40		85	°C
Temperature Sensor Slope	dT_S			0.5		K/LSB
Temperature Sensor Offset	OTs			±2		К

Mechanical Characteristics

Parameter	Symbol	Condition	Min	Тур	Max	Units
Cross Axis Sensitivity	S	relative contribution between any two of the three axes		1		%
Alignment Error	E _A	relative to package outline		±0.5		o

© Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.

2. Absolute maximum ratings

Parameter	Condition	Min	Max	Units		
Malta and a Committee Dia	V_{DD} Pin	-0.3	4.25	V		
Voltage at Supply Pin	V _{DDIO} Pin	-0.3	4.25	V		
Voltage at any Logic Pin	Non-Supply Pin	-0.3	V _{DDIO} +0.3	V		
Passive Storage Temp. Range	≤ 65% rel. H.	-50	+150	°C		
None-volatile memory (NVM) Data Retention	T = 85°C, after 15 cycles	10		У		
	Duration ≤ 200µs		10,000	g		
Mechanical Shock	Duration \leq 1.0ms		2,000	g		
	Free fall onto hard surfaces		1.8	m		
	HBM, at any Pin		2	kV		
ESD	CDM		500	V		
	MM		200	V		

Note:

Stress above these limits may cause damage to the device. Exceeding the specified electrical limits may affect the device reliability or cause malfunction.

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



3. Block diagram

Figure 1 shows the basic building blocks of the BMA280:

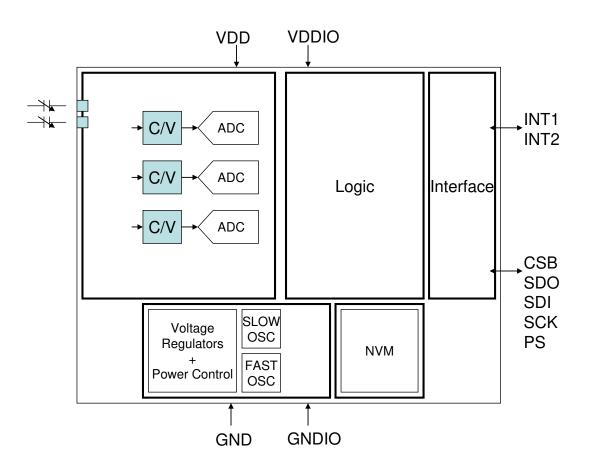


Figure 1: Block diagram of BMA280

© Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



4. Functional description

Note: Default values for registers can be found in chapter 6.

4.1 Supply voltage and power management

The BMA280 has two distinct power supply pins:

- V_{DD} is the main power supply for the internal blocks;
- V_{DDIO} is a separate power supply pin used for supplying power for the interface

There are no limitations on the voltage levels of both pins relative to each other, as long as each of them lies within its operating range. Furthermore, the device can be completely switched off (VDD = 0V) while keeping the VDDIO supply on (VDDIO > 0V) or vice versa.

When the V_{DDIO} supply is switched off, all interface pins (CSB, SDI, SCK, PS) must be kept close to GND_{IO} potential.

The device contains a power-on reset (POR) generator. It resets the logic part and the register values after powering-on V_{DD} and V_{DDIO} . Please note, that all application specific settings which are not equal to the default settings (refer to 6.2 register map), must be re-set to its designated values after POR.

There are no constraints on the switching sequence of both supply voltages. In case the I²C interface shall be used, a direct electrical connection between V_{DDIO} supply and the PS pin is needed in order to ensure reliable protocol selection. For SPI interface mode the PS pin must be directly connected to GND_{IO} .

© Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



4.2 Power modes

The BMA280 has six different power modes. Besides normal mode, which represents the fully operational state of the device, there are five energy saving modes: deep-suspend mode, suspend mode, standby mode, low-power mode 1 and low-power mode 2.

The possible transitions between the power modes are illustrated in figure 2:

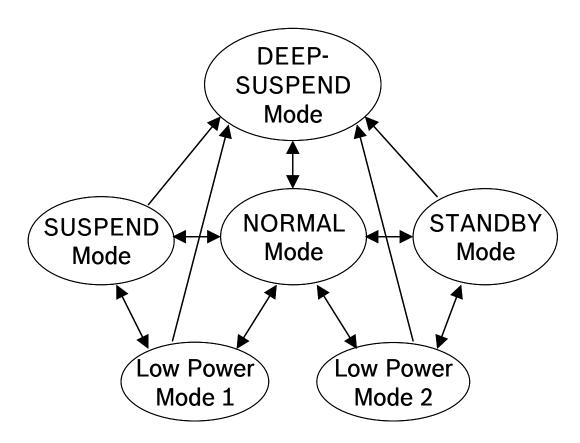


Figure 2: Power mode transition diagram

After **power-up** BMA280 is in normal mode so that all parts of the device are held powered-up and data acquisition is performed continuously.

In **deep-suspend** mode the device reaches the lowest possible power consumption. Only the interface section is kept alive. No data acquisition is performed and the content of the configuration registers is lost. Deep suspend mode is entered (left) by writing '1' ('0') to the $(0x11) \ deep_suspend$ bit while $(0x11) \ suspend$ bit is set to '0'. The I²C watchdog timer remains functional. The $(0x11) \ deep_suspend$ bit, the $(0x34) \ spi3$ bit, $(0x34) \ i2c_wdt_en$ bit and the $(0x34) \ i2c_wdt_sel$ bit are functional in deep-suspend mode. Equally the interrupt level and driver configuration registers $(0x20) \ int1_lvl$, $(0x20) \ int1_od$, $(0x20) \ int2_lvl$, and $(0x20) \ int2_od$ are accessible. Still it is possible to enter normal mode by performing a softreset as described in chapter 4.8. Please note, that all application specific settings which are not equal to the default settings (refer to 6.2 register map), must be re-set to its designated values after leaving deep-suspend mode.

BST-BMA280-DS000-11 | Revision 1.8 | August 2014

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



In **suspend mode** the whole analog part is powered down. No data acquisition is performed. While in suspend mode the latest acceleration data and the content of all configuration registers are kept. Writing to and reading from registers is supported except from the (0x3E) fifo_config_1, (0x30) fifo_config_0 and (0x3F) fifo_data register. It is possible to enter normal mode by performing a softreset as described in chapter 4.8.

Suspend mode is entered (left) by writing '1' ('0') to the (0x11) suspend bit after bit (0x12) lowpower_mode has been set to '0'. Although write access to registers is supported at the full interface clock speed (SCL or SCK), a waiting period must be inserted between two consecutive write cycles (please refer also to section 7.2.1).

In **standby mode** the analog part is powered down, while the digital part remains largely operational. No data acquisition is performed. Reading and writing registers is supported without any restrictions. The latest acceleration data and the content of all configuration registers are kept. Standby mode is entered (left) by writing '1' ('0') to the (0x11) suspend bit after bit (0x12) lowpower_mode has been set to '1'. It is also possible to enter normal mode by performing a softreset as described in chapter 4.8.

In **low-power mode 1**, the device is periodically switching between a sleep phase and a wakeup phase. The wake-up phase essentially corresponds to operation in normal mode with complete power-up of the circuitry. The sleep phase essentially corresponds to operation in suspend mode. Low-power mode is entered (left) by writing '1' ('0') to the (0x11) lowpower_en bit with bit (0x12) lowpower_mode set to '0'. Read access to registers is possible except from the (0x3F) fifo_data register. However, unless the register access is synchronised with the wake-up phase, the restrictions of the suspend mode apply.

Low-power mode 2 is very similar to low-power mode 1, but register access is possible at any time without restrictions. It consumes more power than low-power mode 1. In low-power mode 2 the device is periodically switching between a sleep phase and a wake-up phase. The wake-up phase essentially corresponds to operation in normal mode with complete power-up of the circuitry. The sleep phase essentially corresponds to operation in standby mode. Low-power mode is entered (left) by writing '1' ('0') to the (0x11) lowpower_en bit with bit (0x12) lowpower_mode set to '1'.

The **timing behaviour** of the low-power modes 1 and 2 depends on the setting of the (0x12) sleeptimer_mode bit. When (0x12) sleeptimer_mode is set to '0', the event-driven time-base mode (EDT) is selected. In EDT the duration of the wake-up phase depends on the number of samples required by the enabled interrupt engines. If an interrupt is detected, the device stays in the wake-up phase as long as the interrupt condition endures (non-latched interrupt), or until the latch time expires (temporary interrupt), or until the interrupt is reset (latched interrupt). If no interrupt is detected, the device enters the sleep phase immediately after the required number of acceleration samples have been taken and an active interface access cycle has ended. The EDT mode is recommended for power-critical applications which do not use the FIFO. Also, EDT mode is compatible with legacy BST sensors. Figure 3 shows the timing diagram for low-power modes 1 and 2 when EDT is selected.

BST-BMA280-DS000-11 | Revision 1.8 | August 2014

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.

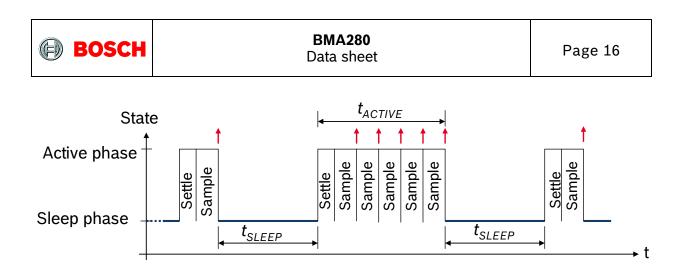


Figure 3: Timing Diagram for low-power mode 1/2, EDT

When (0x12) sleeptimer_mode is set to '1', the equidistant-sampling mode (EST) is selected. The use of the EST mode is recommended when the FIFO is used since it ensures that equidistant samples are sampled into the FIFO regardless of whether the active phase is extended by active interrupt engines or interface activity. In EST mode the sleep time t_{SLEEP} is defined as shown in Figure 4. The FIFO sampling time t_{SAMPLE} is the sum of the sleep time t_{SLEEP} and the sensor data sampling time t_{SSMP} . Since interrupt engines can extend the active phase to exceed the sleep time t_{SLEEP} , equidistant sampling is only guaranteed if the bandwidth has been chosen such that $1/(2 * bw) = n * t_{SLEEP}$ where *n* is an integer. If this condition is infringed, equidistant sampling is not possible. Once the sleep time has elapsed the device will store the next available sample in the FIFO. This set-up condition is not recommended as it may result in timing jitter.

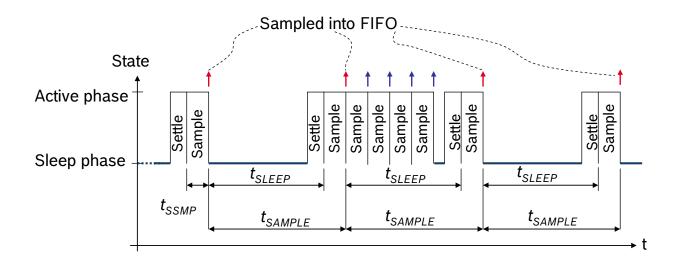


Figure 4: Timing Diagram for low-power mode 1/2, EST

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



The sleep time for lower-power mode 1 and 2 is set by the (0x11) sleep_dur bits as shown in the following table:

(0x11)	Sleep Phase Duration
sleep_dur	t _{sleep}
0000b	0.5ms
0001b	0.5ms
0010b	0.5ms
0011b	0.5ms
0100b	0.5ms
0101b	0.5ms
0110b	1ms
0111b	2ms
1000b	4ms
1001b	6ms
1010b	10ms
1011b	25ms
1100b	50ms
1101b	100ms
1110b	500ms
1111b	1s

Table 3: Sleep phase duration settings

The current consumption of the BMA280 in low-power mode 1 ($I_{DD/p1}$) and low-power mode 2 ($I_{DD/p2}$) can be estimated with the following formulae:

$$I_{DDlp1} \approx rac{t_{sleep} \cdot I_{DDsum} + t_{active} \cdot I_{DD}}{t_{sleep} + t_{active}}$$
.

$$I_{DDlp2} \approx \frac{t_{sleep} \cdot I_{DDsbm} + t_{active} \cdot I_{DD}}{t_{sleep} + t_{active}}$$

When estimating the length of the wake-up phase t_{active} , the corresponding typical wake-up time, $t_{w,up1}$ or $t_{w,up2}$ and t_{ut} (given in Table 4) have to be considered:

If bandwidth is >=31.25 Hz: $t_{active} = t_{ut} + t_{w,up1} - 0.9 \text{ ms}$ (or $t_{active} = t_{ut} + t_{w,up2} - 0.9 \text{ ms}$) else: $t_{active} = 4 t_{ut} + t_{w,up1} - 0.9 \text{ ms}$ (or $t_{active} = 4 t_{ut} + t_{w,up2} - 0.9 \text{ ms}$)

During the wake-up phase all analog modules are held powered-up, while during the sleep phase most analog modules are powered down. Consequently, a wake-up time of at least $t_{w,up1}$ ($t_{w,up2}$) is needed to settle the analog modules so that reliable acceleration data are generated.

BST-BMA280-DS000-11 | Revision 1.8 | August 2014

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



4.3 Sensor data

4.3.1 Acceleration data

The width of acceleration data is 14 bits given in two's complement representation. The 14 bits for each axis are split into an MSB upper part (one byte containing bits 13 to 6) and an LSB lower part (one byte containing bits 5 to 0 of acceleration and a (0x02, 0x04, 0x06) new_data flag). Reading the acceleration data registers shall always start with the LSB part. In order to ensure the integrity of the acceleration data, the content of an MSB register is locked by reading the corresponding LSB register (shadowing procedure). When shadowing is enabled, the MSB must always be read in order to remove the data lock. The shadowing procedure can be disabled (enabled) by writing '1' ('0') to the bit shadow_dis. With shadowing disabled, the content of both MSB and LSB registers is updated by a new value immediately. Unused bits of the LSB registers may have any value and should be ignored. The (0x02, 0x04, 0x06) new_data flag of each LSB register is set if the data registers have been updated. The flag is reset if either the corresponding MSB or LSB part is read.

Two different streams of acceleration data are available, unfiltered and filtered. The unfiltered data is sampled with 2kHz. The sampling rate of the filtered data depends on the selected filter bandwidth and is always twice the selected bandwidth (BW = ODR/2). Which kind of data is stored in the acceleration data registers depends on bit (0x13) data_high_bw. If (0x13) data_high_bw is '0' ('1'), then filtered (unfiltered) data is stored in the registers. Both data streams are offset-compensated.

The bandwidth of filtered acceleration data is determined by setting the (0x10) bw bit as followed:

	-	
bw	Bandwidth	Update Time t _{ut}
00xxx	*)	-
01000	7.81Hz	64ms
01001	15.63Hz	32ms
01010	31.25Hz	16ms
01011	62.5Hz	8ms
01100	125Hz	4ms
01101	250Hz	2ms
01110	500Hz	1ms
01111	unfiltered	0.5ms
1xxxx	*)	-

Table 4: Bandwidth configuration

*) Note: Settings 00xxx result in a bandwidth of 7.81 Hz; settings 1xxxx result in ODR_{max} (unfiltered signal). It is recommended to actively set an application specific and an appropriate bandwidth and to use the range from '01000b' to '01111b' only in order to be compatible with future products.

BST-BMA280-DS000-11 | Revision 1.8 | August 2014

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



The BMA280 supports four different acceleration measurement ranges. A measurement range is selected by setting the (0x0F) range bits as follows:

Range	Acceleration measurement range	Resolution
0011	±2g	0.244mg/LSB
0101	±4g	0.488mg/LSB
1000	±8g	0.977mg/LSB
1100	±16g	1.953mg/LSB
others	reserved	-

Table 5: Range selection

4.3.2 Temperature sensor

The width of temperature data is 8 bits given in two's complement representation. Temperature values are available in the (0x08) temp register.

The slope of the temperature sensor is 0.5 K/LSB, its center temperature is 23° C [(0x08) temp = 0x00].

© Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



4.4 Self-test

This feature permits to check the sensor functionality by applying electrostatic forces to the sensor core instead of external accelerations. By actually deflecting the seismic mass, the entire signal path of the sensor can be tested. Activating the self-test results in a static offset of the acceleration data; any external acceleration or gravitational force applied to the sensor during active self-test will be observed in the output as a superposition of both acceleration and self-test signal.

Before the self-test is enabled the g-range should be set to 4 g. The self-test is activated individually for each axis by writing the proper value to the (0x32) self_test_axis bits ('01b' for x-axis, '10b' for y-axis, '11b' for z-axis, '00b' to deactivate self-test). It is possible to control the direction of the deflection through bit (0x32) self_test_sign. The excitation occurs in negative (positive) direction if (0x32) self_test_sign = '0b' ('1b'). After the self-test is enabled, the user should wait 50ms before interpreting the acceleration data.

In order to ensure a proper interpretation of the self-test signal it is recommended to perform the self-test for both (positive and negative) directions and then to calculate the difference of the resulting acceleration values. Table 6 shows the minimum differences for each axis. The actually measured signal differences can be significantly larger.

Table 6: Self-test difference values

	x-axis signal	y-axis signal	z-axis signal
resulting minimum difference signal	800 mg	800 mg	400 mg

It is recommended to perform a reset of the device after a self-test has been performed. If the reset cannot be performed, the following sequence must be kept to prevent unwanted interrupt generation: disable interrupts, change parameters of interrupts, wait for at least 50ms, enable desired interrupts.

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



4.5 Offset compensation

Offsets in measured signals can have several causes but they are always unwanted and disturbing in many cases. Therefore, the BMA280 offers an advanced set of four digital offset compensation methods which are closely matched to each other. These are slow, fast, and manual compensation as well as inline calibration.

The compensation is performed with unfiltered data, and is then applied to both, unfiltered and filtered data. If necessary the result of this computation is saturated to prevent any overflow errors (the smallest or biggest possible value is set, depending on the sign). However, the registers used to read and write compensation values have a width of 8 bits.

An overview of the offset compensation principle is given in figure 5:

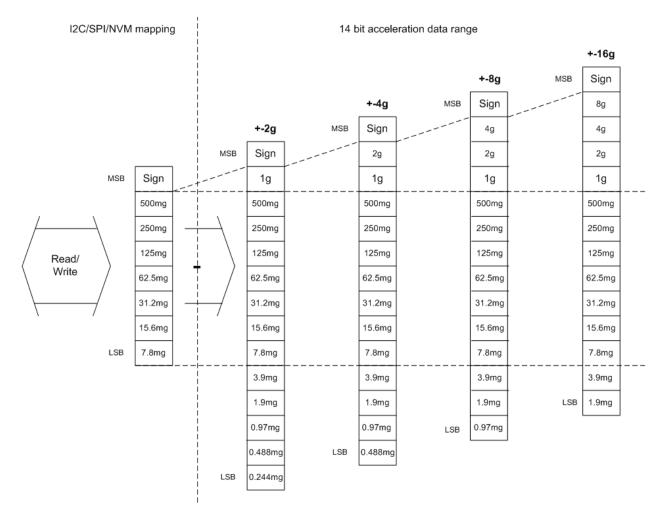


Figure 5: Principle of offset compensation

Bosch Sensortec

© Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



The public offset compensation registers (0x38) offset_x, (0x39) offset_y, (0x3A) offset_z are images of the corresponding registers in the NVM. With each image update (see section 4.6 Non-volatile memory for details) the contents of the NVM registers are written to the public registers. The public registers can be over-written by the user at any time. After changing the contents of the public registers by either an image update or manually, all 8bit values are extended to 14bit values for internal computation. In the opposite direction, if an internally computed value changes it is converted to an 8bit value and stored in the public register.

Depending on the selected g-range the conversion from 14bit to 8bit values can result in a loss of accuracy of one to several LSB. This is shown in figure 5.

In case an internally computed compensation value is too small or too large to fit into the corresponding register, it is saturated in order to prevent an overflow error.

By writing '1' to the (0x36) offset_reset bit, all offset compensation registers are reset to zero.

© Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



4.5.1 Slow compensation

Slow compensation is based on a 1^{st} order high-pass filter, which continuously drives the average value of the output data stream of each axis to zero. The bandwidth of the high-pass filter is configured with bit (0x37) cut_off according to Table 7.

Tuble 1. Compensation period Settings		
(0x37) cut_off	high-pass filter bandwidth	Example <i>bw</i> = 500 Hz
0b	$\frac{1Hz \times bw *}{1000 Hz}$	$\frac{1Hz \times 500 Hz}{1000 Hz} = 0.5 Hz$
1b	$\frac{10Hz \times bw *}{1000 Hz}$	$\frac{10Hz \times 500 Hz}{1000 Hz} = 5 Hz$

Table 7: Compensation period settings

*bw: please insert selected decimal data bandwidth value [Hz] from table 4

The slow compensation can be enabled (disabled) for each axis independently by setting the bits (0x36) hp_x_en , hp_y_en , hp_z_en to '1' ('0'), respectively.

Slow compensation should not be used in combination with low-power mode. In low-power mode the conditions (availability of necessary data) for proper function of slow compensation are not fulfilled.

4.5.2 Fast compensation

Fast compensation is a one-shot process by which the compensation value is set in such a way that when added to the raw acceleration, the resulting acceleration value of each axis approaches the target value. This is best suited for "end-of-line trimming" with the customer's device positioned in a well-defined orientation. For fast compensation the g-range has to be switched to 2g.

The algorithm in detail: An average of 16 consecutive acceleration values is computed and the difference between target value and computed value is written to (0x38, 0x39, 0x3A) offset_filt_x/y/z. The public registers (0x38, 0x39, 0x3A) offset_filt_x/y/z are updated with the contents of the internal registers (using saturation if necessary) and can be read by the user.

Fast compensation is triggered for each axis individually by setting the (0x36) cal_trigger bits as shown in Table 8:

(0x36) cal_trigger	Selected Axis
00b	none
01b	х
10b	У
11b	Z

 Table 8: Fast compensation axis selection

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



Register (0x36) cal_trigger is a write-only register. Once triggered, the status of the fast correction process is reflected in the status bit (0x36) cal_rdy. Bit (0x36) cal_rdy is '0' while the correction is in progress. Otherwise it is '1'. Bit (0x36) cal_rdy is '0' when (0x36) cal_trigger is not '00'.

For the fast offset compensation, the compensation target can be chosen by setting the bits (0x37) offset_target_x, (0x37) offset_target_y, and (0x37) offset_target_z according to Table 9:

(0x37) offset_target_x/y/z	Target value
00b	0g
01b	+1g
10b	-1g
11b	0g

Fast compensation should not be used in combination with any of the low-power modes. In low-power mode the conditions (availability of necessary data) for proper function of fast compensation are not fulfilled.

4.5.3 Manual compensation

The contents of the public compensation registers (0x38, 0x39, 0x3A) offset_filt_x/y/z can be set manually via the digital interface. It is recommended to write into these registers directly after a new data interrupt has occurred in order not to disturb running offset computations.

Writing to the offset compensation registers is not allowed while the fast compensation procedure is running.

4.5.4 Inline calibration

For certain applications, it is often desirable to calibrate the offset once and to store the compensation values permanently. This can be achieved by using one of the aforementioned offset compensation methods to determine the proper compensation values and then storing these values permanently in the NVM. See section 4.6 Non-volatile memory for details of the storing procedure.

Each time the device is reset, the compensation values are loaded from the non-volatile memory into the image registers and used for offset compensation until they are possibly overwritten using one of the other compensation methods.

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.



4.6 Non-volatile memory

The entire memory of the BMA280 consists of three different kinds of registers: hard-wired, volatile, and non-volatile. Part of it can be both read and written by the user. Access to non-volatile memory is only possible through (volatile) image registers.

Altogether, there are eight registers (octets) with NVM backup which are accessible by the user. The addresses of the image registers range from 0x38 to 0x3C. While the addresses up to 0x3A are used for offset compensation (see 4.4 Offset Compensation), addresses 0x3B and 0x3C are general purpose registers not linked to any sensor-specific functionality.

The content of the NVM is loaded to the image registers after a reset (either POR or softreset) or after a user request which is performed by writing '1' to the write-only bit (0x33) nvm_load. As long as the image update is in progress, bit (0x33) nvm_rdy is '0', otherwise it is '1'.

The image registers can be read and written like any other register.

Writing to the NVM is a three-step procedure:

- 1. Write the new contents to the image registers.
- 2. Write '1' to bit (0x33) *nvm_prog_mode* in order to unlock the NVM.
- 3. Write '1' to bit (0x33) nvm_prog_trig and keep '1' in bit (0x33) nvm_prog_mode in order to trigger the write process.

Writing to the NVM always renews the entire NVM contents. It is possible to check the write status by reading bit $(0x33) nvm_rdy$. While $(0x33) nvm_rdy = '0'$, the write process is still in progress; if $(0x33) nvm_rdy = '1'$, then writing is completed. As long as the write process is ongoing, no change of power mode and image registers is allowed. Also, the NVM write cycle must not be initiated while image registers are updated, in low-power mode, and in suspend mode.

Please note that the number of permitted NVM write-cycles is limited as specified in Table 1. The number of remaining write-cycles can be obtained by reading bits (0x33) nvm_remain.

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany. Note: Specifications within this document are subject to change without notice.